

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

1. (currently amended) A package with electronic circuitry, comprising:
 - a first card comprising at least one open cell;
 - a second card comprising at least one protruding receptacle having an open side, wherein said protruding receptacle is matingly nested within said open cell;
 - a third card comprising a first closed cell, mated to said second card such that said first closed cell spans across said open side; and
 - a fourth card comprising a second closed cell and circuitry, mated to said third card such that said second closed cell is breachably aligned with said first closed cell[[.]],wherein said cards are non-conductive.
2. (canceled)
3. (original) The package of claim 1, wherein at least a portion of said receptacle is pliable.
4. (original) The package of claim 1, wherein a portion of said circuitry spans said second closed cell.
5. (original) The package of claim 1, wherein said fourth card includes an electronic monitoring device receiving area in communication with said circuitry.

6. (currently amended) A package with electronic circuitry, comprising:
a first card comprising at least one protruding receptacle having an open side;
a second card comprising a first closed cell, mated to said first card such that said first closed cell spans across said open side; and
a third card comprising a second closed cell and circuitry, mated to said second card such that said second closed cell is breachably aligned with said first closed cell[[.]],
wherein said cards are non-conductive.
7. (canceled)
8. (original) The package of claim 6, wherein at least a portion of said receptacle is pliable.
9. (original) The package of claim 6, wherein a portion of said circuitry spans said second closed cell.
10. (original) The package of claim 6, wherein said fourth card includes an electronic monitoring device receiving area in communication with said circuitry.
11. (original) A package with electronic circuitry, comprising:
a first card comprising at least one protruding receptacle having an open side;
a conductive protective layer mated to said first card such that said protective layer spans across said open side; and
a second card comprising a closed cell, and circuitry with a dielectric overlay;
and,
wherein said second card is mated to said first card such that said dielectric overlay is adjacent to said protective layer and said closed cell is breachably aligned with said open side.
12. (original) The package of claim 11, wherein said cards are non-conductive.

13. (original) The package of claim 11, wherein at least a portion of said receptacle is pliable.

14. (original) The package of claim 11, wherein said fourth card includes an electronic monitoring device receiving area in communication with said circuitry.

15. (original) The package of claim 11, wherein said protective layer is conductive.

16. (original) The package of claim 11, wherein a portion of said circuitry spans said closed cell.

17. (original) The package of claim 11, wherein said overlay is applied on top of and covers at least a portion of said circuitry.

18. (currently amended) A method of monitoring the removal of an item from a receptacle, comprising:

- providing a receptacle with an open side to receive and store an item;
- inserting said item into said receptacle;
- blocking said open side with a first card comprising a first breachable gate;
- placing a second card, comprising a circuit that spans a second breachable gate, to said first card such that said first and second breachable gates are aligned,
- forcing said item from an end opposite said open side, through said breachable gates to break said circuit,
- recording the event of breaking said circuit, and
- removing said item from said receptacle[1.1],

wherein said cards are non-conductive.